

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Hunatech Co., Ltd.	12/20/2007
RECEIVING PARTY DATA	
Name:	Ehwa Diamond Ind. Co., Ltd.
Street Address:	520-2, Won-Dong, Osan-City
City:	Kyungki-Do
State/Country:	KOREA, DEMOCRATIC PEOPLE'S REPUBLIC OF
Postal Code:	447-804
PROPERTY NUMBERS Total: 1	
Property Type	Number
Patent Number:	6818029
CORRESPONDENCE DATA	
Fax Number:	(212)382-0888
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	212-382-0700
Email:	mbellach@ostrolenk.com
Correspondent Name:	Ostrolenk, Faber, Gerb & Soffen, L.L.P.
Address Line 1:	1180 Avenue of the Americas
Address Line 4:	New York, NEW YORK 10036
ATTORNEY DOCKET NUMBER:	P.2803-52 V6597
NAME OF SUBMITTER:	Max Moskowitz
Total Attachments: 2 source=00901557#page1.tif source=00901557#page2.tif	

OP \$40.00 6818029

ASSIGNMENT

US Patent No. 6,818,029

Issued November 16, 2004

WHEREAS, HUNATECH CO., LTD., having a principal place of business at Kyungki-do, Republic of Korea (hereinafter designated as the undersigned) owns an invention in certain new and useful improvements in CONDITIONER FOR POLISHING PAD AND METHOD FOR MANUFACTURING THE SAME for which United States Patent Number 6,818,029 was issued on November 16, 2004, and;

WHEREAS, EHWA DIAMOND IND. CO., LTD., having a principal place of business at 520-2, Won-Dong, Osan-City, Kyungki-Do 447-804, Republic of Korea, its heirs, successors, legal representatives and assigns (hereinafter designated as the Assignee) is desirous of acquiring the entire right, title and interest in said U.S. Letters Patent and to any reissue or reexamination of said patent that may be granted in the United States of America;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to the undersigned in hand paid, the receipt of which is hereby acknowledged, and other good and valuable consideration, the undersigned has (have) sold, assigned and transferred, and by these presents do sell, assign and transfer unto said Assignee the full and exclusive right, title and interest to said U.S. patent and any reissues, reexaminations and extensions thereof for the full term or terms for which the same may be granted.

The undersigned agree(s) to execute all papers necessary in connection any reexamination or reissue applications thereof.

The undersigned agree(s) to execute all papers necessary in connection with any interference which may be declared concerning this Letters Patent(s) or reissue patent or reexamination patent issued thereon and to cooperate with the Assignee in every way possible in obtaining and producing evidence and proceeding with such interference.

The undersigned agree(s) to perform all affirmative acts which may be necessary to vest all rights therein hereby conveyed to said Assignee as fully and entirely as the same would have been held by the undersigned if this Assignment and sale had not been made.

The undersigned hereby covenants that it has the full right to convey the entire interest herein assigned, and that it has not executed, and will not execute, any agreement in conflict herewith.

The undersigned hereby grant(s) the law firm of OSTROLENK, FABER, GERB & SOFFEN, LLP the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

In witness thereof, this Assignment has been executed by the undersigned on the date(s) opposite the undersigned name(s).

For: HUNATECH CO., LTD.

Date 20 - Dec - 07

Signature *Jinpo Kim*
Name and Title Jin - Po Kim, President

This assignment should preferably be acknowledged before a United States Consul or Notary Public. If not, then the execution by the Inventor(s) should be witnessed by at least two other persons who should sign here.

Witness <u>BEOM YOUNG MYUNG</u>	Signature <u><i>by H. Y.</i></u>
Witness <u>SUNG KO</u>	Signature <u><i>[Signature]</i></u>
Witness <u>JEOM HONG YOON</u>	Signature <u><i>jeom</i></u>